

CONTRACT NOTICE

Supplies

I. CONTRACTING AUTHORITY

NAME, ADDRESSES AND CONTACT POINT(S):

Instytut Technologii Elektronowej, Al. Lotników 32/46, Attn: Zbigniew Poznański PL-02-668 Warszawa. E-mail: poznan@ite.waw.pl. Fax +48 22 847 06 31.

Further information can be obtained at: Instytut Technologii Elektronowej, Al. Lotników 32/46, Attn: Michał Urbański, PL-02-668 Warszawa. E-mail: urbanski@ite.waw.pl. Fax +48 22 847 06 31. URL: www.ite.waw.pl.

Specifications and additional documents can be obtained at: Instytut Technologii Elektronowej, Al. Lotników 32/46, Attn: Jadwiga Skorupska, PL-02-668 Warszawa. E-mail: skorupsk@ite.waw.pl. Fax +48 22 847 06 31. URL: www.ite.waw.pl.

Tenders to participate must be sent to: Instytut Technologii Elektronowej, Al. Lotników 32/46, Attn: Jadwiga Skorupska, PL-02-668 Warszawa. E-mail: skorupsk@ite.waw.pl. Fax +48 22 548 78 46. URL: www.ite.waw.pl.

II. THE OBJECT OF THE ORDER

The object of the order is **delivery of the device for structure assembly microsystems (die bonder)**.

III. EVALUATION OF THE TENDER

- Price - 100 %

IV. TENDER

Time-limit for receipt of tenders or requests to participate:

20.07.2011 – 10:00.

2011-07-07